

ProLight PM6B-3LFx 3W RGB Power LED Technical Datasheet Version: 1.2

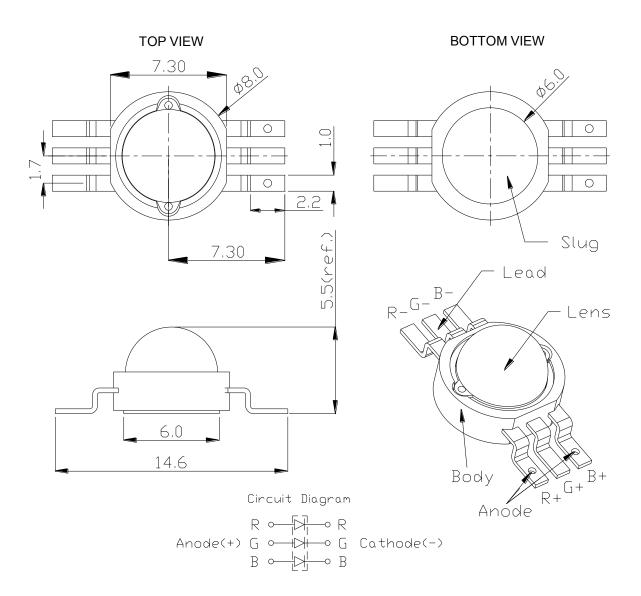
### **Features**

- R, G, B three color in one Package
- High flux per LED
- Good color uniformity
- Low-temp. & lead free reflow soldering
- More energy efficient than incandescent and most halogen lamps
- Low Voltage DC operated
- Instant light (less than 100ns)
- No UV

### **Typical Applications**

- Reading lights (car, bus, aircraft)
- Portable (flashlight, bicycle)
- Uplighters/Downlighters
- Decorative/Entertainment
- Bollards/Security/Garden
- Cove/Undershelf/Task
- Indoor/Outdoor Commercial and Residential Architectural
- Automotive Ext (Stop-Tail-Turn, CHMSL, Mirror Side Repeat)
- LCD backlights

### **Emitter Mechanical Dimensions**

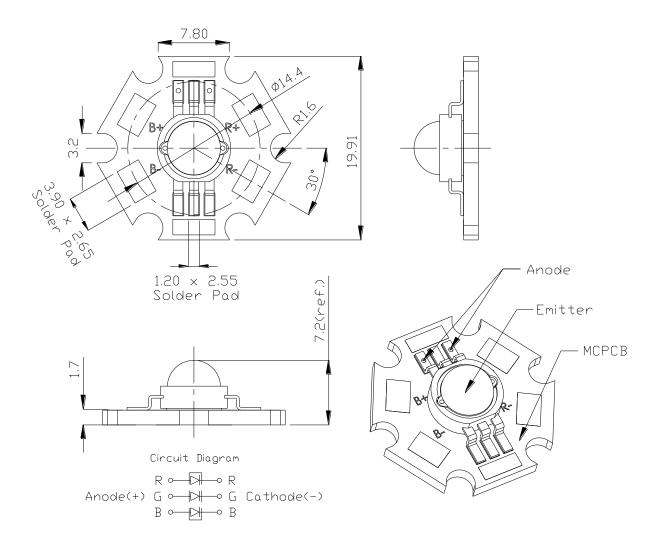


#### Notes:

- 1. The Anode side of the device is denoted by a hole in the lead frame.
- 2. Electrical insulation between the case and the board is required --- slug of device is not electrically neutral. Do not electrically connect either the anode or cathode to the slug.
- 3. Drawing not to scale.
- 4. All dimensions are in millimeters.
- 5. All dimendions without tolerances are for reference only.
- 6. Please do not bend the leads of the LED, otherwise it will damage the LED.
- 7. Please do not use a force of over 3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.

<sup>\*</sup>The appearance and specifications of the product may be modified for improvement without notice.

### **Star Mechanical Dimensions**



#### Notes:

- 1. Slots in aluminum-core PCB for M3 or #4 mounting screw.
- 2. Electrical interconnection pads labeled on the aluminum-core PCB with "+" and "-" to denote positive and negative, respectively. All positive pads are interconnected, as are all negative pads, allowing for flexibility in array interconnection.
- 3. Drawing not to scale.
- 4. All dimensions are in millimeters.
- 5. All dimendions without tolerances are for reference only.
- 6. Please do not use a force of over 3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.

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# Flux Characteristics at 350mA, $T_J = 25$ °C

Radiation Colo	Color	Part Number		Lumious Flux ΦV (lm)	
	Color	Emitter	Star	Minimum	Typical
	Red			25	30
Lambertian	Green	PM6B-3LFE	PM6B-3LFS	55	66
	Blue			10	12.5

- ProLight maintains a tolerance of ± 10% on flux and power measurements.
- Please do not drive at rated current more than 1 second without proper heat sink.

## Optical Characteristics at 350mA, T<sub>J</sub> = 25°C

		Dominant Wavelength $\lambda_D$ , or Color Temperature CCT		Total included Angle	Viewing Angle
Color	Min.	Тур.	Max.	(degrees) $\theta_{0.90V}$	(degrees) 2 θ <sub>1/2</sub>
Red	613.5 nm	623 nm	631 nm	180	130
Green	515 nm	525 nm	535 nm	180	130
Blue	455 nm	465 nm	475 nm	180	130

- ProLight maintains a tolerance of ± 1nm for dominant wavelength measurements.
- ProLight maintains a tolerance of ± 5% for CCT measurements.

## Electrical Characteristics at 350mA, T<sub>J</sub> = 25°C

	Forward Voltage V <sub>F</sub> (V)		
Color	Min.	Тур.	Max.
Red	1.75	2.4	3.1
Green	2.85	3.5	4.1
Blue	2.85	3.5	4.1

## **Absolute Maximum Ratings**

Parameter	Red/Green/Blue	
DC Forward Current (mA)	350	
Peak Pulsed Forward Current (mA)	500	
Average Forward Current (mA)	350	
ESD Sensitivity (HBM per MIL-STD-883E Method 3015.7	> ±500V	
LED Junction Temperature (°C)	120	
Aluminum-core PCB Temperature (°C)	105	
Storage & Operating Temperature (°C)	-40 to +105	
Soldering Temperature(°C)	235°C	

# **Dominant Wavelength Bin Structure**

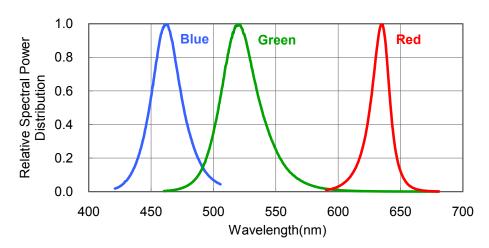
Color	Bin Code	Minimum Dominant Wavelength (nm)	Maximum Dominant Wavelength (nm)
Red	2	613.5	620.5
Reu	4	620.5	631.0
	А	515	520
Croon	1	520	525
Green	2	525	530
	3	530	535
	А	455	460
Blue	1	460	465
	2	465	470
	3	470	475

<sup>•</sup> ProLight maintains a tolerance of ± 1nm for dominant wavelength measurements.

Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

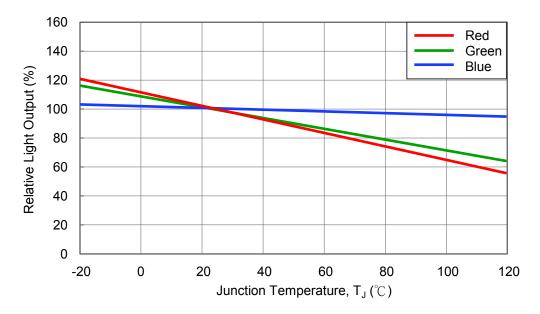
## Color Spectrum, T<sub>J</sub> = 25°C

### 1. Blue · Green · Red



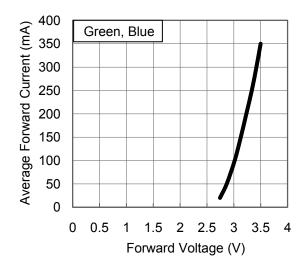
## **Light Output Characteristics**

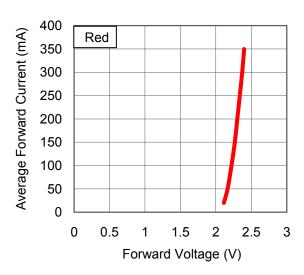
### Relative Light Output vs. Junction Temperature at 350mA



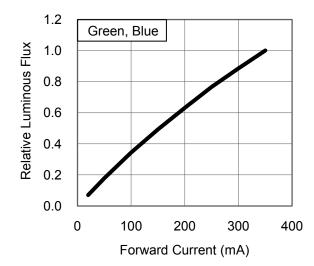
## Forward Current Characteristics, T<sub>J</sub> = 25°C

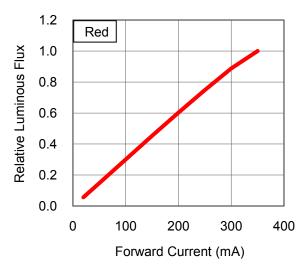
### 1. Forward Voltage vs. Forward Current





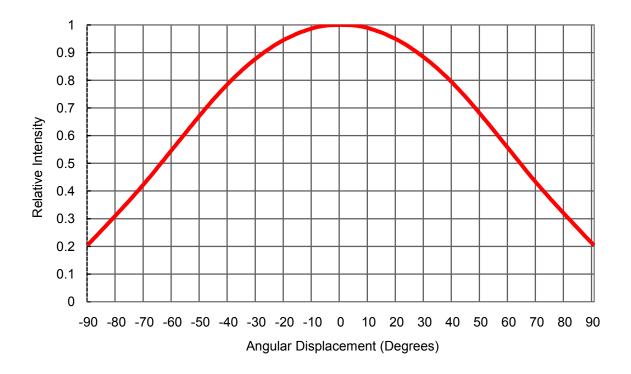
### 2. Forward Current vs. Normalized Relative Luminous Flux





# **Typical Representative Spatial Radiation Pattern**

### **Lambertian Radiation Pattern**



# **Qualification Reliability Testing**

Stress Test	Stress Conditions	Stress Duration	Failure Criteria	
Room Temperature	25°C, I <sub>F</sub> = max DC (Note 1)	1000 hours	Note 2	
Operating Life (RTOL)	25 G, IF - Max DG (Note 1)	1000 110015	Note 2	
Wet High Temperature	85°C/60%RH, I <sub>F</sub> = max DC (Note 1)	1000 hours	Note 2	
Operating Life (WHTOL)	00 0/00/01(11, 1F - 111ax DO (Note 1)	1000 110019		
Wet High Temperature	85°C/85%RH, non-operating	1000 hours	Note 2	
Storage Life (WHTSL)	05 C/05/MKH, Hon-operating	1000 110019		
High Temperature	110°C, non-operating	1000 hours	Note 2	
Storage Life (HTSL)	110 O, Horr-operating	1000 110013	NOIG Z	
Low Temperature	-40°C, non-operating	1000 hours	Note 2	
Storage Life (LTSL)	-40 G, non-operating	1000 110019		
Non-operating	-40°C to 120°C, 30 min. dwell,	200 cycles	Note 2	
Temperature Cycle (TMCL)	<5 min. transfer	200 Cycles	Note 2	
Non-operating	-40°C to 120°C, 20 min. dwell,	200 cycles	Note 2	
Thermal Shock (TMSK)	<20 sec. transfer	200 cycles	Note 2	
Mechanical Shock	1500 G, 0.5 msec. pulse,		Note 3	
Wedianical Shock	5 shocks each 6 axis		Note 5	
Natural Drop	On concrete from 1.2 m, 3X		Note 3	
Natural Brop	On concrete from 1.2 m, 5X		Note 5	
Variable Vibration	10-2000-10 Hz, log or linear sweep rate,		Note 3	
Frequency	20 G about 1 min., 1.5 mm, 3X/axis		14010 0	
Solderability	Steam age for 16 hrs., then solder dip		Solder coverage	
Golderability	at 260°C for 5 sec.		on lead	

### Notes:

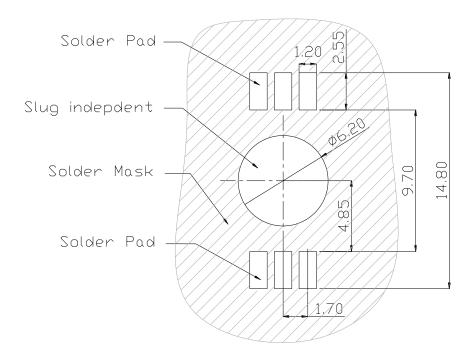
- 1. Depending on the maximum derating curve.
- 2. Criteria for judging failure

Item	Test Condition	Criteria for Judgement	
пеш	rest Condition	Min.	Max.
Forward Voltage (V <sub>F</sub> )	I <sub>F</sub> = max DC		Initial Level x 1.1
Luminous Flux or Radiometric Power ( $\Phi_V$ )	I <sub>F</sub> = max DC	Initial Level x 0.7	
Reverse Current (I <sub>R</sub> )	V <sub>R</sub> = 5V		50 μA

<sup>\*</sup> The test is performed after the LED is cooled down to the room temperature.

3. A failure is an LED that is open or shorted.

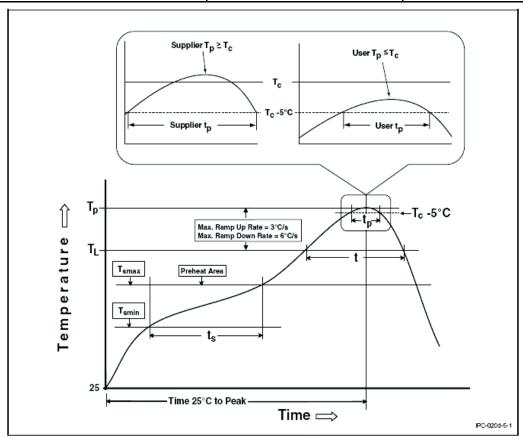
# **Recommended Solder Pad Design**



- All dimensions are in millimeters.
- Electrical isolation is required between Slug and Solder Pad.

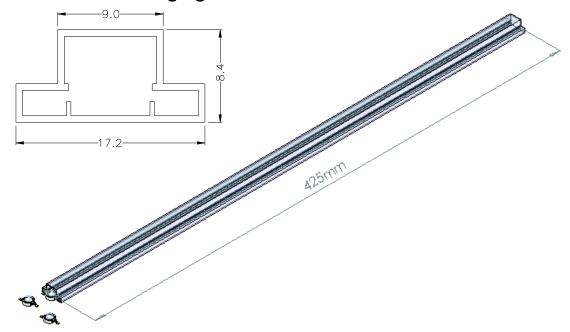
### **Reflow Soldering Condition**

Profile Feature	Sn-Pb Eutectic Assembly	Low-Temp. & Pb-Free Assembly (58Bi-42Sn Eutectic Alloy)	
Preheat & Soak			
Temperature min (T <sub>smin</sub> )	100 °C	90 °C	
Temperature max (T <sub>smax</sub> )	150 °C	120 °C	
Time ( $T_{smin}$ to $T_{smax}$ )	60-120 seconds	60-120 seconds	
Average Ramp-Up Rate (T <sub>smax</sub> to T <sub>P</sub> )	3 °C / second max.	2 °C / second max.	
Liquidous temperature (T <sub>L</sub> )	183°C	138°C	
Time at liquidous (t <sub>L</sub> )	60-150 seconds	20-50 seconds	
Peak package body temperature (T <sub>P</sub> )	235°C	185°C	
Time (t <sub>P</sub> ) within 5°C of the specified	20 accords	20 seconds	
classification temperature (T <sub>C</sub> )	20 seconds		
Average ramp-down rate (T <sub>P</sub> to T <sub>smax</sub> )	6 °C/second max.	3 °C/second max.	
Time 25°C to Peak Temperature	6 minutes max.	4 minutes max.	

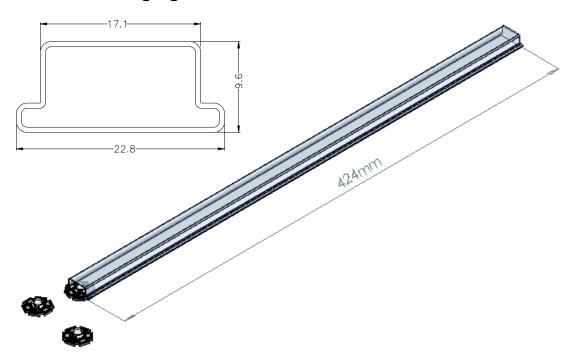


- All temperatures refer to topside of the package, measured on the package body surface.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

# **Emitter Tube Packaging**



## **Star Tube Packaging**



#### Notes:

- 1. Emitter 50 pieces per tube and Star 20 pieces per tube.
- 2. Drawing not to scale.
- 3. All dimensions are in millimeters.
- 4. All dimendions without tolerances are for reference only.

<sup>\*\*</sup>Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30°C and humidity less than 40% RH.

#### **Precaution for Use**

- Storage
  - Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30°C and humidity less than 40% RH. It is also recommended to return the LEDs to the MBB and to reseal the MBB.
- The slug is is not electrically neutral. Therefore, we recommend to isolate the heat sink.
- The LEDs are sensitive to electrostatic discharge. Appropriate ESD protection measures
  must be taken when working with the LEDs. Non-compliance with ESD protection measures
  may lead to damage or destruction of the LEDs.
- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- Please avoid rapid cooling after soldering.
- Components should not be mounted on warped direction of PCB.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When cleaning is required, isopropyl alcohol should be used.
- When the LEDs are illuminating, operating current should be decide after considering the package maximum temperature.
- The appearance, specifications and flux bin of the product may be modified for improvement without notice. Please refer to the below website for the latest datasheets.